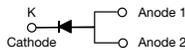


SMD Photovoltaic Solar Cell Protection Schottky Rectifier

 Ultra Low $V_F = 0.34 \text{ V}$ at $I_F = 5 \text{ A}$
TMBS® eSMP® Series

TO-277A (SMPC)

RoHS
 COMPLIANT
 HALOGEN
FREE

FEATURES

- Very low profile - typical height of 1.1 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in solar cell junction box as a bypass diode for protection, using DC forward current without reverse bias.

MECHANICAL DATA

Case: TO-277A (SMPC)

Molding compound meets UL 94 V-0 flammability rating
 Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test

| PRIMARY CHARACTERISTICS | |
|-------------------------------|----------------|
| $I_{F(AV)}$ | 10 A |
| V_{RRM} | 45 V |
| I_{FSM} | 180 A |
| V_F at $I_F = 10 \text{ A}$ | 0.41 V |
| $T_{OP \text{ max.}}$ | 150 °C |
| Package | TO-277A (SMPC) |
| Diode variation | Single die |

| MAXIMUM RATINGS ($T_A = 25 \text{ °C}$ unless otherwise noted) | | | |
|---|-------------|-------------|------|
| PARAMETER | SYMBOL | V10P45S | UNIT |
| Device marking code | | 1045S | |
| Maximum repetitive peak reverse voltage | V_{RRM} | 45 | V |
| Maximum DC forward current | $I_F^{(1)}$ | 10 | A |
| | $I_F^{(2)}$ | 4.4 | |
| Peak forward surge current 10 ms single half sine-wave superimposed on rated load | I_{FSM} | 180 | A |
| Junction temperature in DC forward current without reverse bias, $t \leq 1 \text{ h}$ | $T_J^{(3)}$ | ≤ 200 | °C |
| Operating junction temperature range | T_{OP} | -40 to +150 | °C |
| Storage temperature range | T_{STG} | -40 to +175 | °C |

Notes

- (1) Mounted on 30 mm x 30 mm aluminum PCB
- (2) Free air, mounted on recommended copper pad area
- (3) Meets the requirements of IEC 61215 ed. 2 bypass diode thermal test

| ELECTRICAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted) | | | | | | |
|--|----------------------|-----------------------------------|-------------|------|------|---------------|
| PARAMETER | TEST CONDITIONS | SYMBOL | TYP. | MAX. | UNIT | |
| Instantaneous forward voltage | $I_F = 5.0\text{ A}$ | $T_A = 25\text{ }^\circ\text{C}$ | $V_F^{(1)}$ | 0.42 | - | V |
| | $I_F = 10\text{ A}$ | | | 0.48 | 0.57 | |
| | $I_F = 5.0\text{ A}$ | $T_A = 125\text{ }^\circ\text{C}$ | | 0.34 | - | |
| | $I_F = 10\text{ A}$ | | | 0.41 | 0.50 | |
| Reverse current | $V_R = 45\text{ V}$ | $T_A = 25\text{ }^\circ\text{C}$ | $I_R^{(2)}$ | 21 | 800 | μA |
| | | $T_A = 125\text{ }^\circ\text{C}$ | | 9 | 35 | mA |

Notes

- (1) Pulse test: 300 μs pulse width, 1 % duty cycle
 (2) Pulse test: Pulse width $\leq 40\text{ ms}$

| THERMAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted) | | | |
|---|-----------------------|---------|--------------------|
| PARAMETER | SYMBOL | V10P45S | UNIT |
| Typical thermal resistance | $R_{\theta JA}^{(1)}$ | 75 | $^\circ\text{C/W}$ |
| | $R_{\theta JM}^{(2)}$ | 4 | |

Notes

- (1) Free air, mounted on recommended copper pad area; thermal resistance $R_{\theta JA}$ - junction to ambient
 (2) Mounted on 30 mm x 30 mm aluminum PCB; thermal resistance $R_{\theta JM}$ - junction to mount

| ORDERING INFORMATION (Example) | | | | |
|---------------------------------------|-----------------|------------------------|---------------|------------------------------------|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE |
| V10P45S-M3/86A | 0.10 | 86A | 1500 | 7" diameter plastic tape and reel |
| V10P45S-M3/87A | 0.10 | 87A | 6500 | 13" diameter plastic tape and reel |

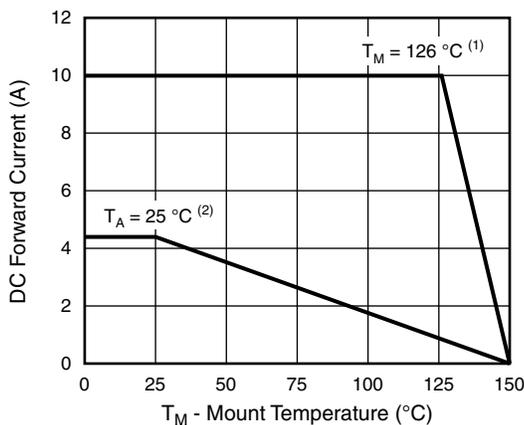
RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)


Fig. 1 - Forward Current Derating Curve

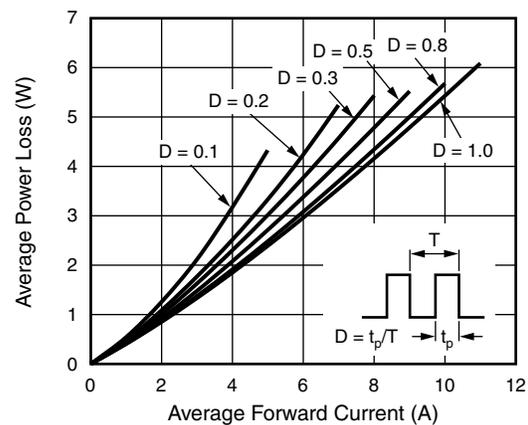


Fig. 2 - Forward Power Loss Characteristics

Notes

- (1) Mounted on 30 mm x 30 mm aluminum PCB; T_M measured at the terminal of cathode band ($R_{\theta JM} = 4\text{ }^\circ\text{C/W}$)
 (2) Free air, mounted on recommended copper pad area ($R_{\theta JA} = 75\text{ }^\circ\text{C/W}$)

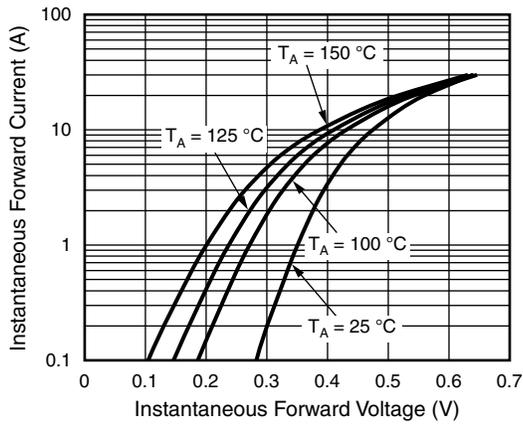


Fig. 3 - Typical Instantaneous Forward Characteristics

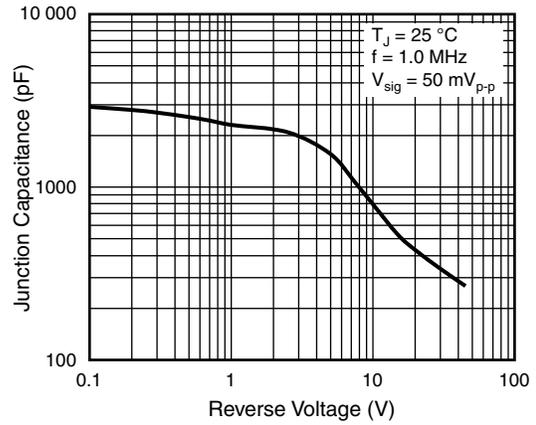


Fig. 5 - Typical Junction Capacitance

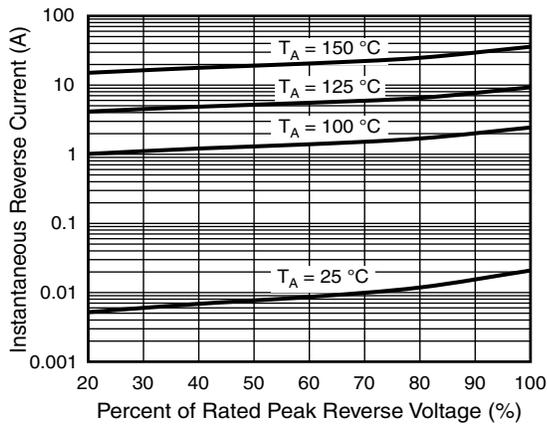


Fig. 4 - Typical Reverse Leakage Characteristics

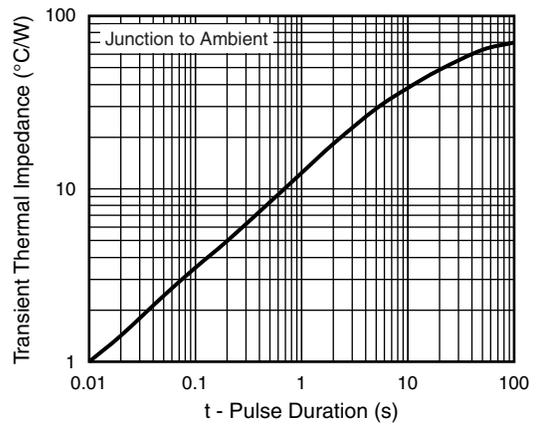
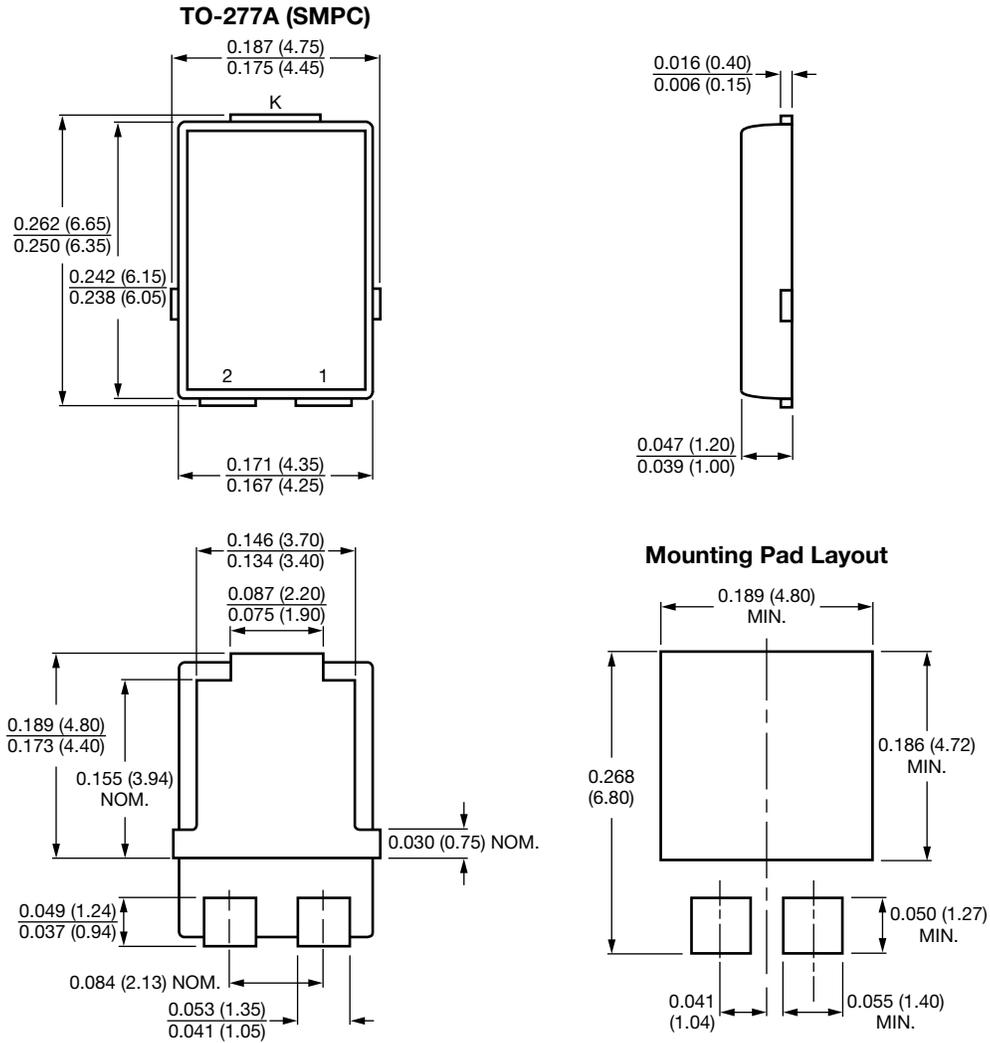


Fig. 6 - Typical Transient Thermal Impedance



PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



Conform to JEDEC TO-277A



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